



**THE DATASHEET OF  
LME49713MA/NOPB**



## LME49713 High Performance, High Fidelity Current Feedback Audio Operational Amplifier

Check for Samples: [LME49713](#)

### FEATURES

- Easily Drives 150Ω Loads
- Optimized for Superior Audio Signal Fidelity
- Output Short Circuit Protection
- 100dB (Typ) PSRR and 88dB (Typ) CMRR
- SOIC High-Performance and TO-99 Packages

### APPLICATIONS

- Ultra High Quality Audio Amplification
- High-Fidelity Preamplifiers
- High-Fidelity Multimedia
- State-of-the-Art Phono Pre Amps
- High-Performance Professional Audio
- High-Fidelity Equalization and Crossover Networks
- High-Performance Line Drivers
- High-Performance Line Receivers
- High-Fidelity Active Filters

### KEY SPECIFICATIONS

- Power Supply Voltage Range:  $\pm 5V$  to  $\pm 18V$
- THD+N,  $f = 1\text{kHz}$  ( $A_V = 1$ ,  $R_L = 100\Omega$ ,  $V_{OUT} = 3V_{RMS}$ ): 0.0006% (typ)
- THD+N,  $f = 1\text{kHz}$  ( $A_V = 1$ ,  $R_L = 600\Omega$ ,  $V_{OUT} = 1.4V_{RMS}$ ): 0.00036% (typ)
- Input Noise Density:  $1.9\text{nV}/\sqrt{\text{Hz}}$  (typ)
- Slew Rate:  $\pm 1900V/\mu\text{s}$  (typ)
- Bandwidth ( $A_V = -1$ ,  $R_L = 2\text{k}\Omega$ ,  $R_F = 1.2\text{k}\Omega$ ): 132 MHz (typ)
- Input Bias Current:  $1.8\mu\text{A}$  (typ)
- Input Offset Voltage: 0.05mV (typ)

### DESCRIPTION

The LME49713 is an ultra-low distortion, low noise, ultra high slew rate current feedback operational amplifier optimized and fully specified for high performance, high fidelity applications. Combining advanced leading-edge process technology with state-of-the-art circuit design, the LME49713 current feedback operational amplifier delivers superior signal amplification for outstanding performance. Operating on a wide supply range of  $\pm 5V$  to  $\pm 18V$ , the LME49713 combines extremely low voltage noise density ( $1.9\text{nV}/\sqrt{\text{Hz}}$ ) with very low THD+N (0.00036%) to easily satisfy the most demanding applications. To ensure that the most challenging loads are driven without compromise, the LME49713 has a high slew rate of  $\pm 1900V/\mu\text{s}$  and an output current capability of  $\pm 100\text{mA}$ . Further, dynamic range is maximized by an output stage that drives 150Ω loads to within 2.9V of either power supply voltage.

The LME49713's outstanding CMRR (88dB), PSRR (100dB), and  $V_{OS}$  (0.05mV) give the amplifier excellent operational amplifier DC performance.

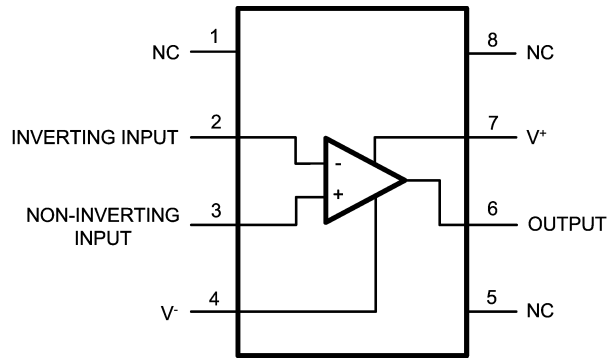
The LME49713 is available in an 8-lead narrow body SOIC and an 8-lead TO-99. Demonstration boards are available.



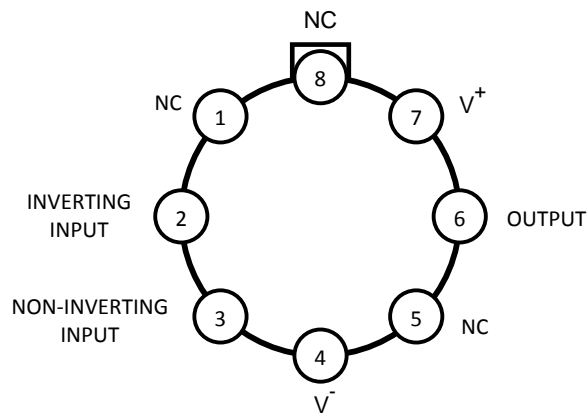
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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**CONNECTION DIAGRAMS**



**Figure 1. 8-Lead SOIC (D Package)**



**Figure 2. 8-Lead TO-99 (LMC Package)**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**ABSOLUTE MAXIMUM RATINGS**<sup>(1)(2)(3)</sup>

Power Supply Voltage ( $V_S = V^+ - V^-$ )	38V
Storage Temperature	-65°C to 150°C
Input Voltage	(V-) - 0.7V to (V+) + 0.7V
Output Short Circuit <sup>(4)</sup>	Continuous
Power Dissipation	Internally Limited
ESD Rating <sup>(5)</sup>	2000V
ESD Rating <sup>(6)</sup>	200V
Junction Temperature	150°C
Thermal Resistance	
$\theta_{JA}$ (MA)	145°C/W
Temperature Range	
$T_{MIN} \leq T_A \leq T_{MAX}$	-40°C $\leq$ T <sub>J</sub> $\leq$ 70°C
Supply Voltage Range	$\pm 5.0V \leq V_S \leq \pm 18V$

- (1) *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list ensured specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not ensured.
- (3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (4) Amplifier output connected to GND, any number of amplifiers within a package.
- (5) Human body model, applicable std. JESD22-A114C.
- (6) Machine model, applicable std. JESD22-A115-A.

**ELECTRICAL CHARACTERISTICS<sup>(1)(2)</sup>**

The following specifications apply for the  $V_S = \pm 15V$ ,  $R_L = 2k\Omega$ ,  $R_{SOURCE} = 10\Omega$ ,  $f_{IN} = 1kHz$ , and  $T_J = 25^\circ C$ , unless otherwise specified.

Symbol	Parameter	Conditions	LME49713		Units (Limits)
			Typical <sup>(3)</sup>	Limit <sup>(4)</sup>	
THD+N	Total Harmonic Distortion + Noise	$A_V = 1$ , $V_{OUT} = 3V_{RMS}$ , $R_F = 1.2k\Omega$ $R_L = 100\Omega$ , $V_{OUT} = 3V_{RMS}$ $R_L = 600\Omega$ , $V_{OUT} = 1.4V_{RMS}$	0.0006 0.00036	0.00071 0.00045	% (max) % (max)
IMD	Intermodulation Distortion	$A_V = 1$ , $V_{IN} = 3V_{RMS}$ Two-tone, 60Hz & 7kHz 4:1	0.00009		%
BW	Bandwidth	$A_V = -1$ , $R_F = 1.2k\Omega$	132		MHz
SR	Slew Rate	$V_O = 20V_{P-P}$ , $A_V = -1$	$\pm 1900$		V/ $\mu s$
FPBW	Full Power Bandwidth	$V_{OUT} = 20V_{P-P}$ , $A_V = -1$	30		MHz
$t_s$	Settling time	$A_V = -1$ , 10V step, 0.1% error range	50		ns
$e_n$	Equivalent Input Noise Voltage	$f_{BW} = 20Hz$ to 20kHz	0.26	0.6	$\mu V_{RMS}$ (max)
	Equivalent Input Noise Density	$f = 1kHz$ $f = 10Hz$	1.9 11.5	4.0	nV/ $\sqrt{Hz}$ (max)
$i_n$	Current Noise Density	$f = 1kHz$ $f = 10Hz$	16 160		pA/ $\sqrt{Hz}$
$V_{OS}$	Input Offset Voltage		$\pm 0.05$	$\pm 1.0$	mV (max)
$\Delta V_{OS}/\Delta Temp$	Average Input Offset Voltage Drift vs Temperature	$-40^\circ C \leq T_A \leq 85^\circ C$	0.29		$\mu V/^\circ C$
PSRR	Average Input Offset Voltage Shift vs Power Supply Voltage	$V_{SUPPLY} = \pm 5V$ to $\pm 15V$ <sup>(5)</sup>	100	95	dB (min)
$I_B$	Input Bias Current	$V_{CM} = 0V$	1.8	6	$\mu A$ (max)
$\Delta I_{OS}/\Delta Temp$	Input Bias Current Drift vs Temperature	$-40^\circ C \leq T_A \leq 85^\circ C$ Inverting input Non-inverting input	4.5 4.7		nA/ $^\circ C$ nA/ $^\circ C$
$I_{OS}$	Input Offset Current	$V_{CM} = 0V$	1.3	5	$\mu A$ (max)
$V_{IN-CM}$	Common-Mode Input Voltage Range		$\pm 13.5$	(V+) – 2.0 (V-) + 2.0	V (min) V (min)
CMRR	Common-Mode Rejection	$-10V < V_{cm} < 10V$	88	86	dB (min)
$Z_{IN}$	Non-inverting-input Input Impedance	$-10V < V_{cm} < 10V$	1.2		M $\Omega$
	Inverting-input Input Impedance	$-10V < V_{cm} < 10V$	58		$\Omega$
$Z_T$	Transimpedance	$V_{OUT} = \pm 10V$			
		$R_L = 200\Omega$	4.2	2.0	M $\Omega$ (min)
		$R_L = \infty$	4.7	2.65	M $\Omega$ (min)
$V_{OUTMAX}$	Maximum Output Voltage Swing	$R_L = 150\Omega$	$\pm 11.1$	$\pm 10.3$	V (min)
		$R_L = 600\Omega$	$\pm 11.6$	$\pm 11.4$	V (min)
$I_{OUT}$	Output Current	$R_L = 150\Omega$ , $V_S = \pm 18V$	$\pm 100$	$\pm 91$	mA (min)
$I_{OUT-CC}$	Instantaneous Short Circuit Current		$\pm 140$		mA
$R_{OUT}$	Output Resistance	$f_{IN} = 5MHz$ , Open-Loop	10		$\Omega$
$I_S$	Total Quiescent Current	$I_{OUT} = 0mA$	8.5	10	mA (max)

- (1) *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list ensured specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not ensured.
- (3) Typical values represent most likely parametric norms at  $T_A = +25^\circ C$ , and at the *Recommended Operation Conditions* at the time of product characterization and are not ensured.
- (4) Datasheet min/max specification limits are specified by test or statistical analysis.
- (5) PSRR is measured as follows:  $V_{OS}$  is measured at two supply voltages,  $\pm 5V$  and  $\pm 15V$ .  $PSRR = |20\log(\Delta V_{OS}/\Delta V_S)|$ .

TYPICAL PERFORMANCE CHARACTERISTICS

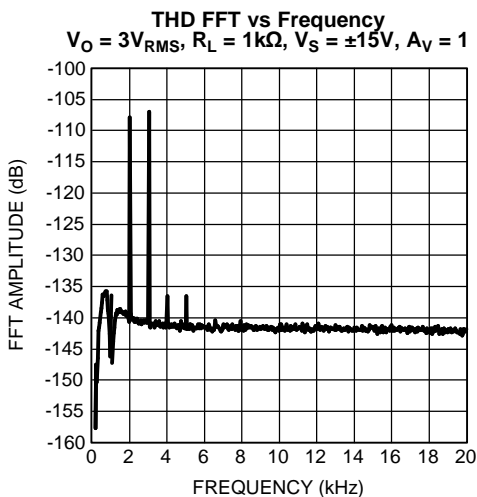


Figure 3.

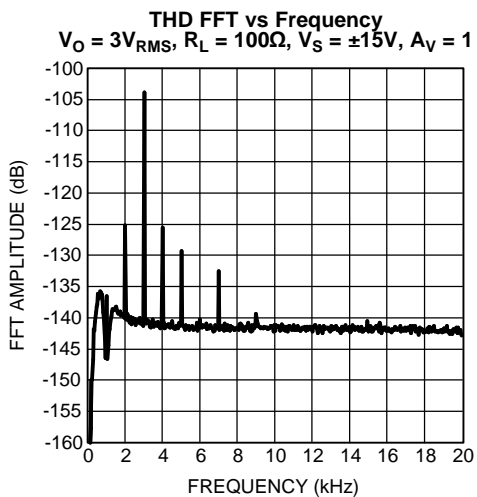


Figure 4.

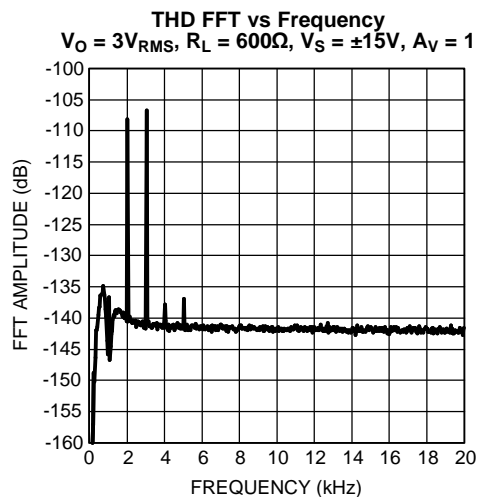


Figure 5.

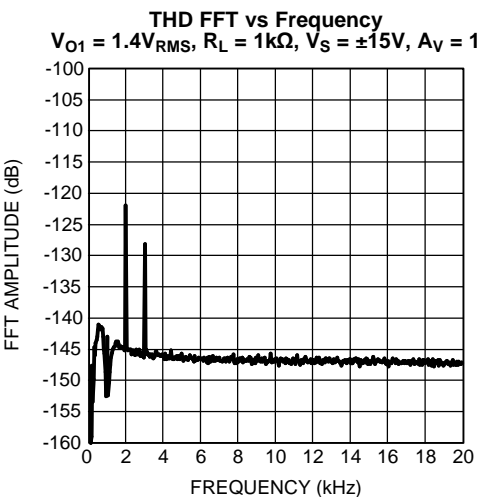


Figure 6.

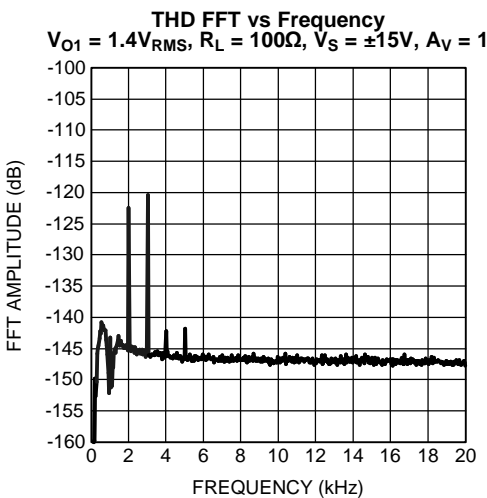


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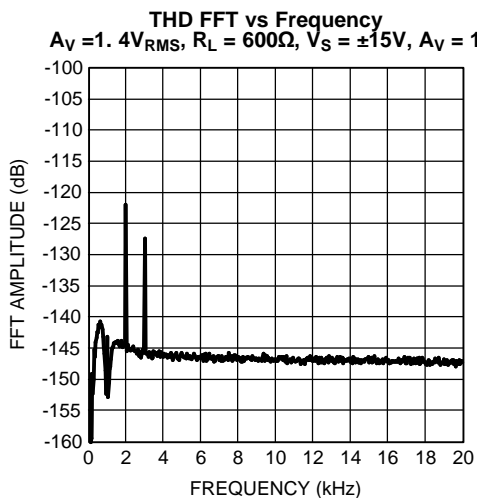


Figure 8.

**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

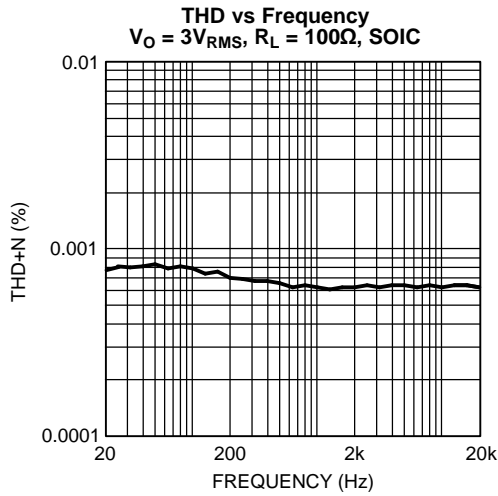


Figure 9.

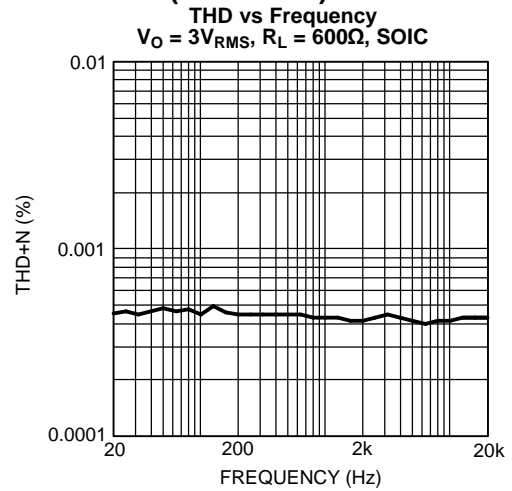


Figure 10.

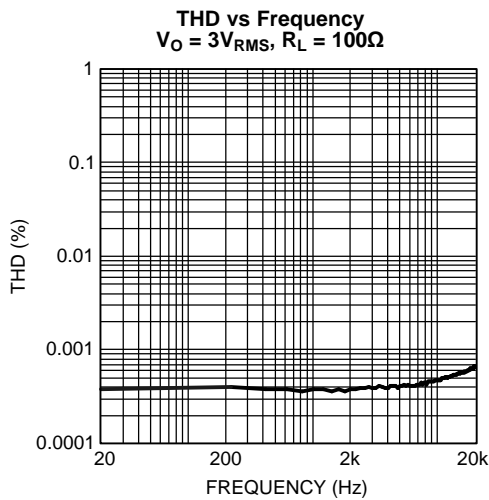


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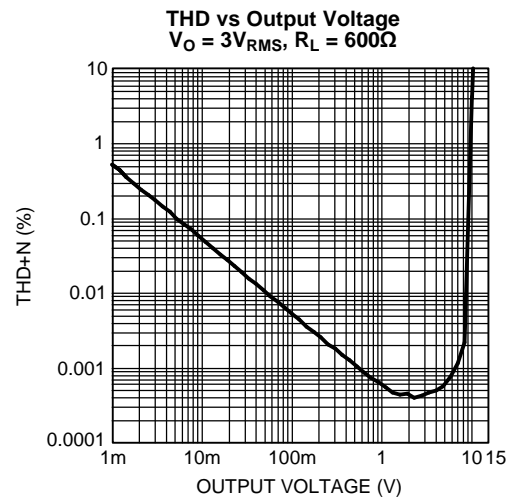


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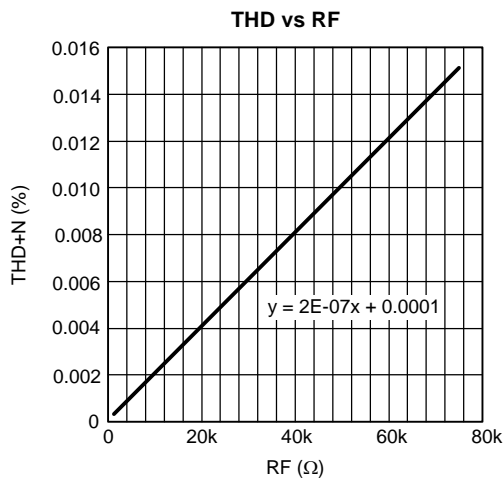


Figure 13.

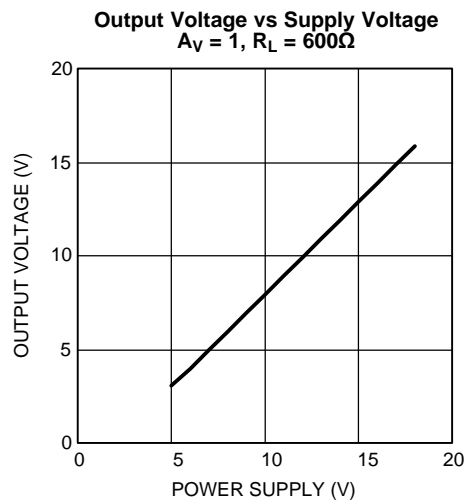


Figure 14.

**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

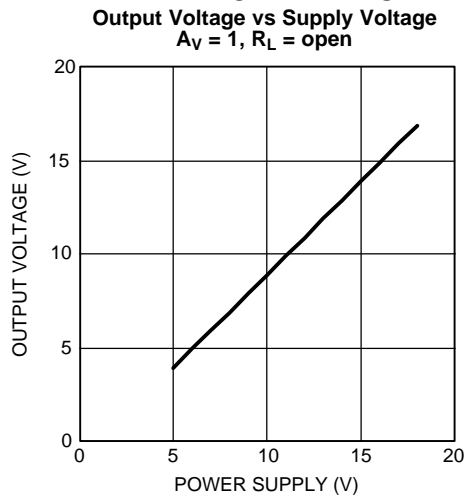


Figure 15.

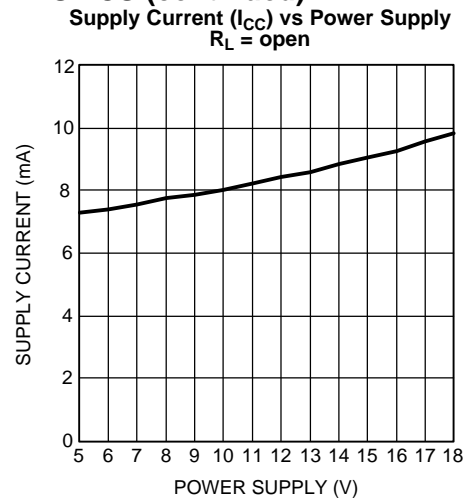


Figure 16.

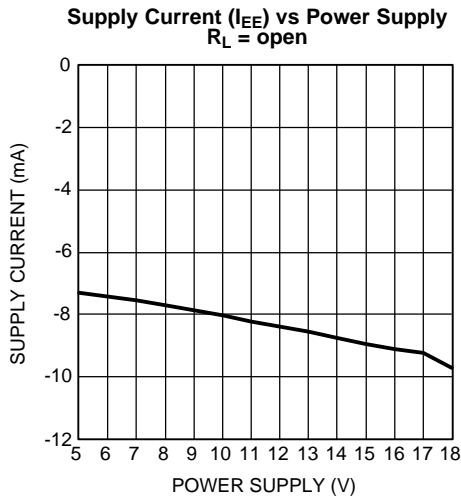


Figure 17.

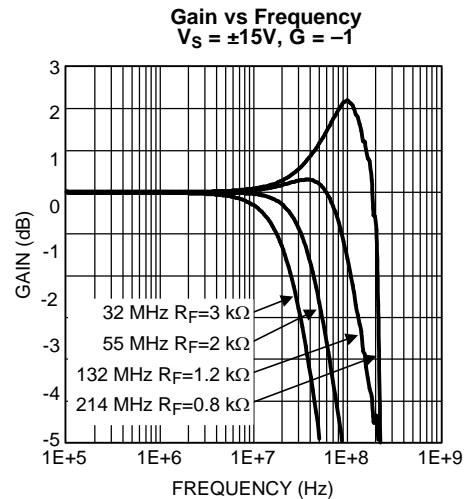


Figure 18.

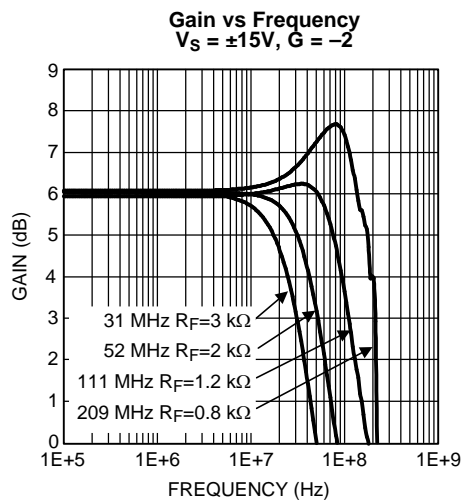


Figure 19.

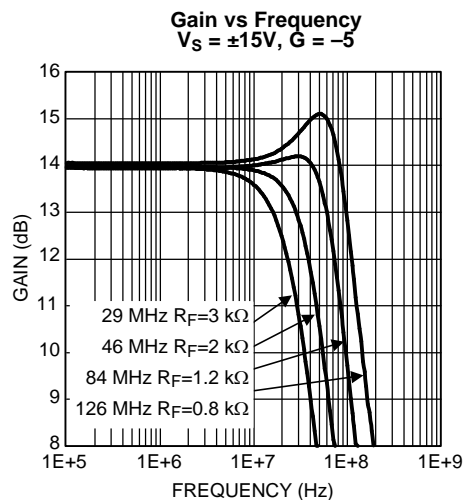


Figure 20.

**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

**Gain vs Frequency**  
 $V_S = \pm 15V, G = -10$

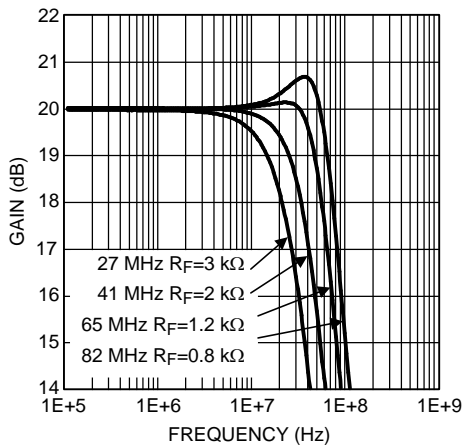


Figure 21.

**Gain vs Frequency**  
 $R_F = 800\Omega, V_S = \pm 15V$

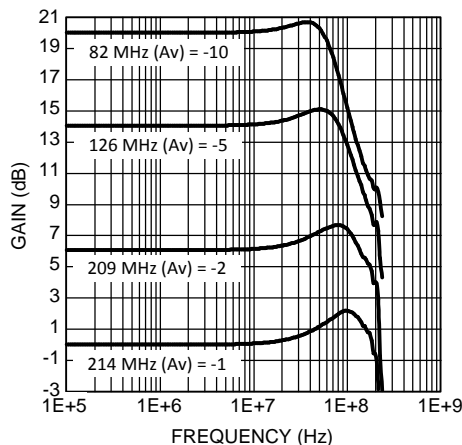


Figure 22.

**Gain vs Frequency**  
 $R_F = 1.2k\Omega, V_S = \pm 15V$

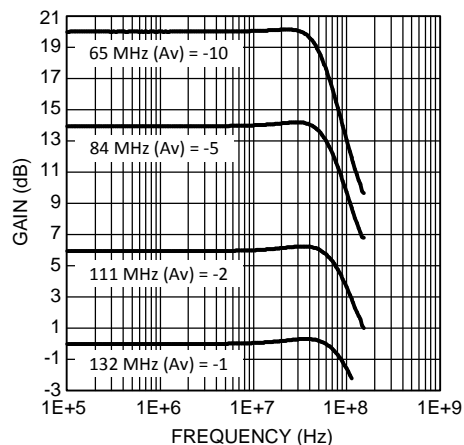


Figure 23.

**Gain vs Frequency**  
 $R_F = 2k\Omega, V_S = \pm 15V$

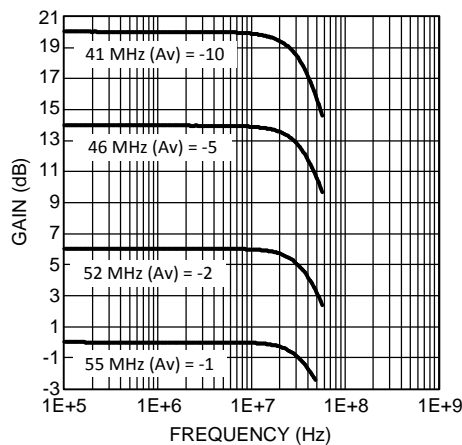


Figure 24.

**Gain vs Frequency**  
 $R_F = 3k\Omega, V_S = \pm 15V$

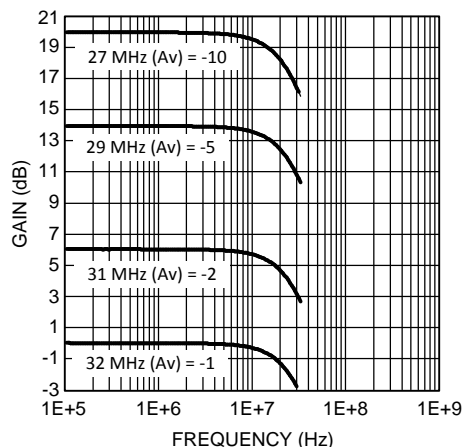


Figure 25.

**CMRR vs Frequency**  
 $V_S = \pm 15V$

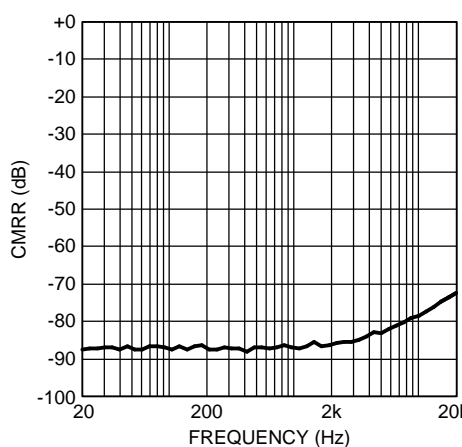


Figure 26.

**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

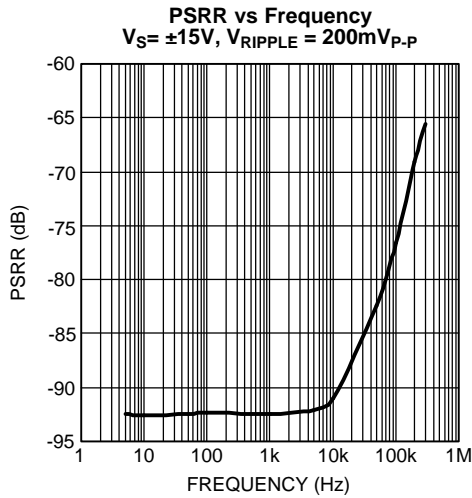


Figure 27.

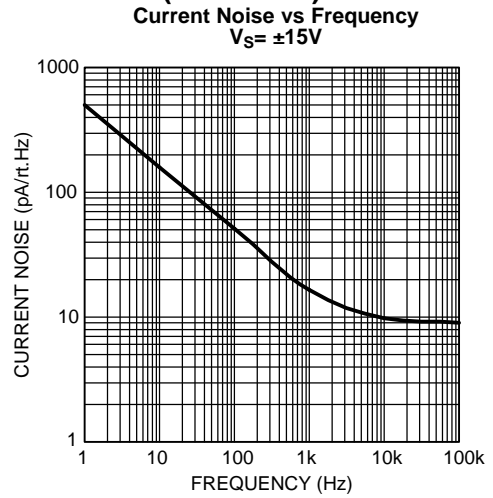


Figure 28.

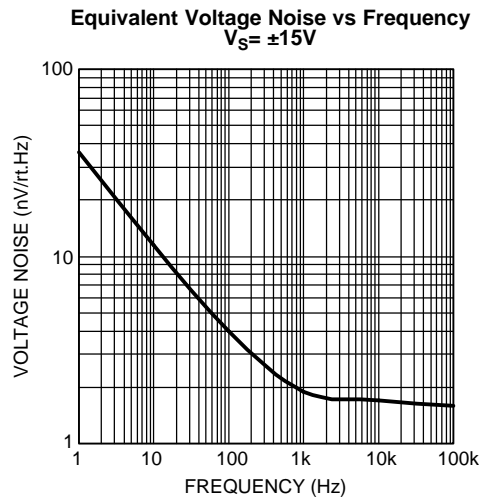


Figure 29.

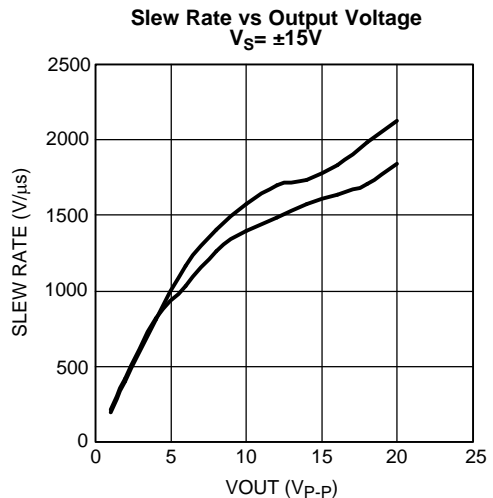


Figure 30.

## APPLICATION INFORMATION

### GENERAL AMPLIFIER FUNCTION

Voltage feedback amplifiers have a small-signal bandwidth that is a function of the closed-loop gain. Conversely, the LME49713 current feedback amplifier features a small-signal bandwidth that is relatively independent of the closed-loop gain. This is shown in [Figure 31](#) where the LME49713's gain is  $-1$ ,  $-2$ ,  $-5$ , and  $-10$ . Like all current feedback amplifiers, the LME49713's closed-loop bandwidth is a function of the feedback resistance value. Therefore,  $R_s$  must be varied to select the desired closed-loop gain.

### POWER SUPPLY BYPASSING AND LAYOUT CONSIDERATIONS

Properly placed and correctly valued supply bypassing is essential for optimized high-speed amplifier operation. The supply bypassing must maintain a wideband, low-impedance capacitive connection between the amplifier's supply pin and ground. This helps preserve high speed signal and fast transient fidelity. The bypassing is easily accomplished using a parallel combination of a  $10\mu\text{F}$  tantalum and a  $0.1\mu\text{F}$  ceramic capacitors for each power supply pin. The bypass capacitors should be placed as close to the amplifier power supply pins as possible.

### FEEDBACK RESISTOR SELECTION ( $R_f$ )

The value of the  $R_f$  is also a dominant factor in compensating the LME49713. For general applications, the LME49713 will maintain specified performance with an  $1.2\text{k}\Omega$  feedback resistor. Although this value will provide good results for most applications, it may be advantageous to adjust this value slightly for best pulse response optimized for the desired bandwidth. In addition to reducing bandwidth, increasing the feedback resistor value also reduces overshoot in the time domain response.

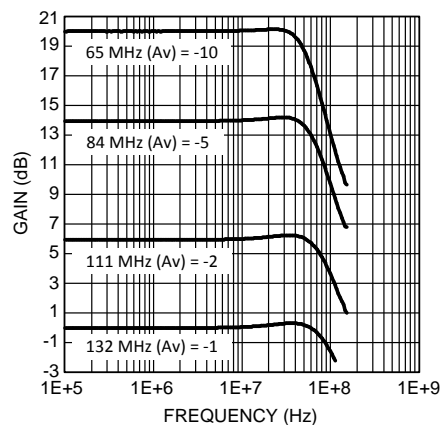


Figure 31. Bandwidth as a Function of Gain

### SLEW RATE CONSIDERATIONS

A current feedback amplifier's slew rate characteristics are different than that of voltage feedback amplifiers. A voltage feedback amplifier's slew rate limiting or non-linear amplifier behavior is dominated by the finite availability of the first stage tail current charging the second stage voltage amplifier's compensation capacitor. Conversely, a current feedback amplifier's slew rate is not constant. Transient current at the inverting input determines slew rate for both inverting and non-inverting gains. The non-inverting configuration slew rate is also determined by input stage limitations. Accordingly, variations of slew rates occur for different circuit topologies.

### DRIVING CAPACITIVE LOADS

The LME49713 can drive significantly higher capacitive loads than many current feedback amplifiers. Although the LME49713 can directly drive as much as  $100\text{pF}$  without oscillating, the resulting response will be a function of the feedback resistor value.

## CAPACITIVE FEEDBACK

It is quite common to place a small lead-compensation capacitor in parallel with a voltage feedback amplifier's feedback resistance,  $R_f$ . This compensation reduces the amplifier's peaking in the frequency domain and damps the transient response. Whereas this yields the expected results when used with voltage feedback amplifiers, this technique must not be used with current feedback amplifiers. The dynamic impedance of capacitors in the feedback loop reduces the amplifier's stability. Instead, reduced peaking in the frequency response and bandwidth limiting can be accomplished by adding an RC circuit to the amplifier's input.

## REVISION HISTORY

Revision	Date	Description
1.0	09/26/07	Initial release.
1.1	09/28/07	Added the Typical Performance curves.
1.2	10/03/07	Input Limit values.
1.3	10/29/07	Edited the Specification table, typical performance curve, and text edits.
1.4	01/29/08	Added more curves in the Typical Performance section.
1.5	07/24/08	Added the Metal Can package.
1.6	08/20/08	Text edits (updated some of the curves' titles).
1.7	08/22/08	Text edits.
1.8	02/08/10	Input changes on typical and limits in the EC table.
1.9	04/23/10	Input Typical and Limit edits on THD+N and $I_{OUT}$ in the EC table.
2.0	06/02/10	Input text edits on the first page.
F	3/28/2013	Changed layout of National Data Sheet to TI format.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LME49713HA/NOPB	LIFEBUY	TO-99	LMC	8		TBD	Call TI	Call TI	-40 to 85		

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

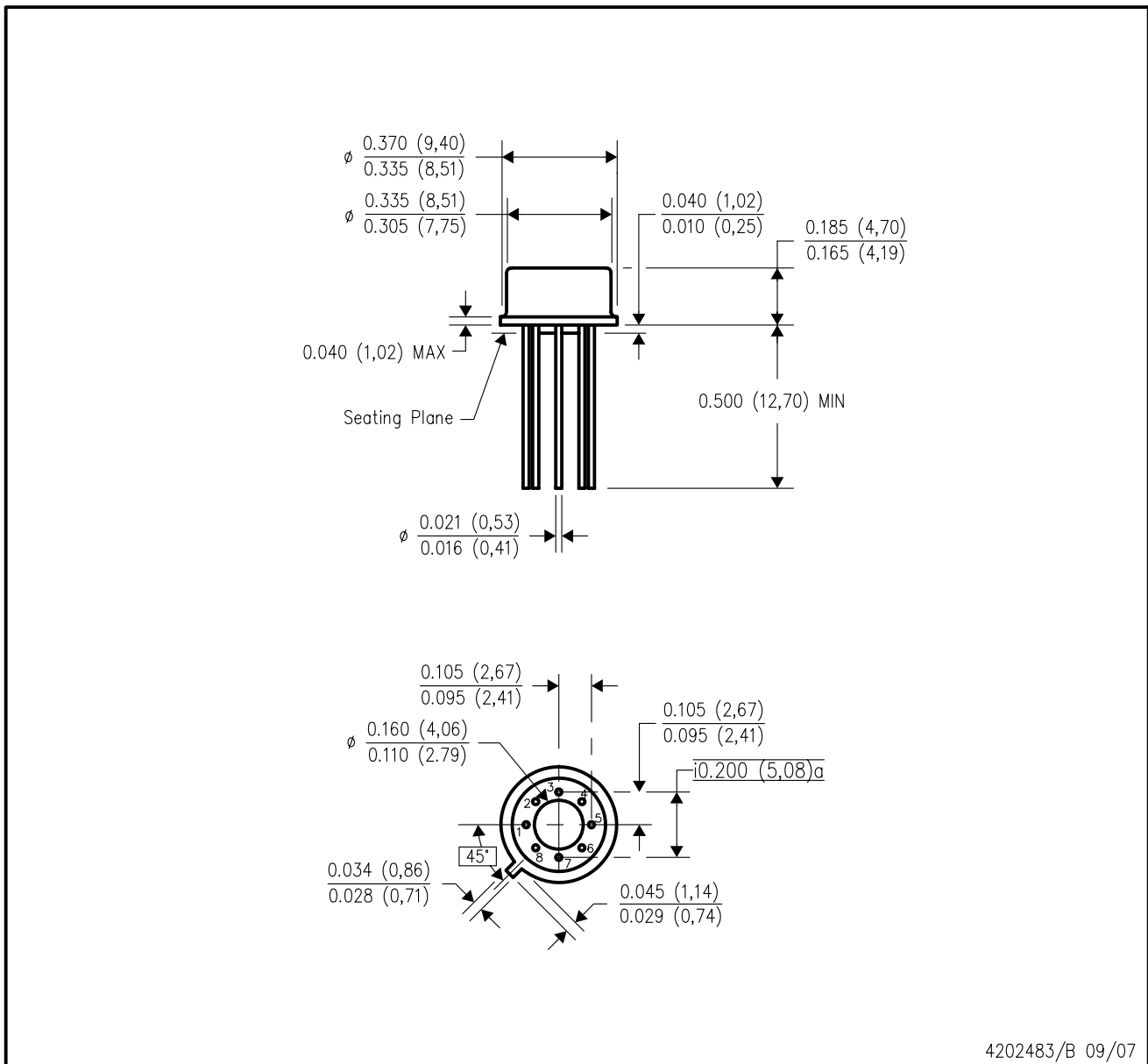
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

LMC (O-MBCY-W8)

METAL CYLINDRICAL PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
  - D. Pin numbers shown for reference only. Numbers may not be marked on package.
  - E. Falls within JEDEC MO-002/TO-99.

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